

Influence of the Defect Structure on the Exsolution Behaviour of Nickel in Epitaxial $\text{SrTi}_{0.9}\text{Nb}_{0.05}\text{Ni}_{0.05}\text{O}_{3-\delta}$ Perovskite Oxide Thin Films

Electroceramics XVII | Virtual Darmstadt | 24 – 28 August 2020

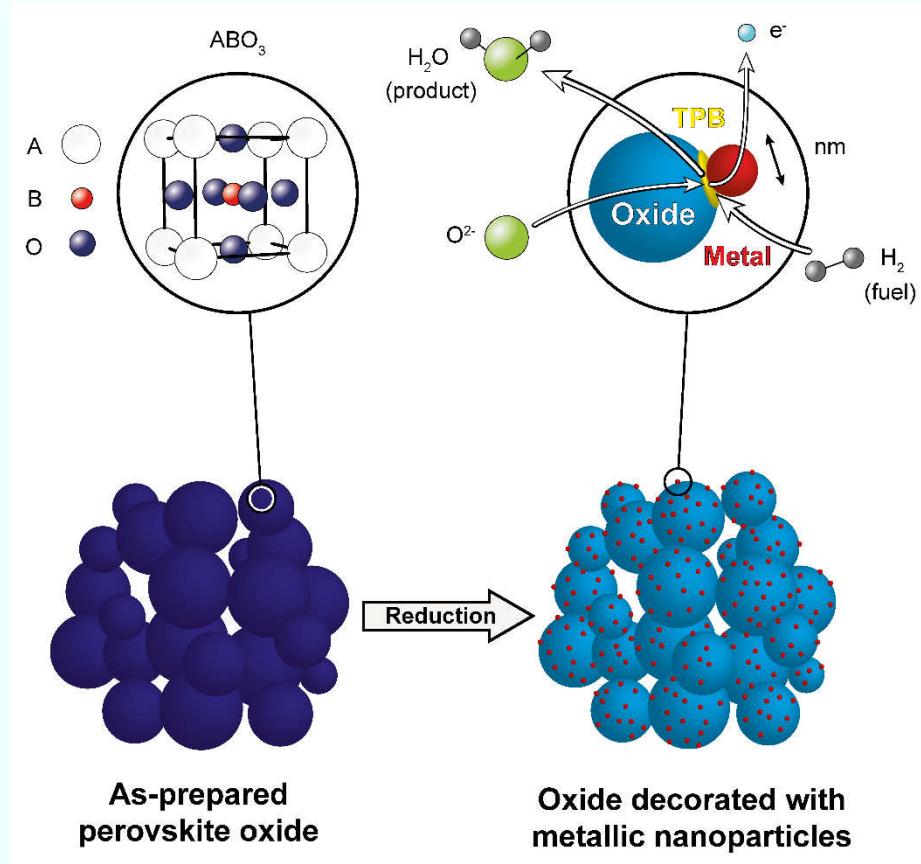
M. L. Weber, M. Wilhelm, L. Jin, U. Breuer, C. Lenser, F. Gunkel, N. H. Menzler, R. Dittmann, R. Waser and O. Guillou



Metal exsolution

Synthesis of supported nanoparticles by metal exsolution

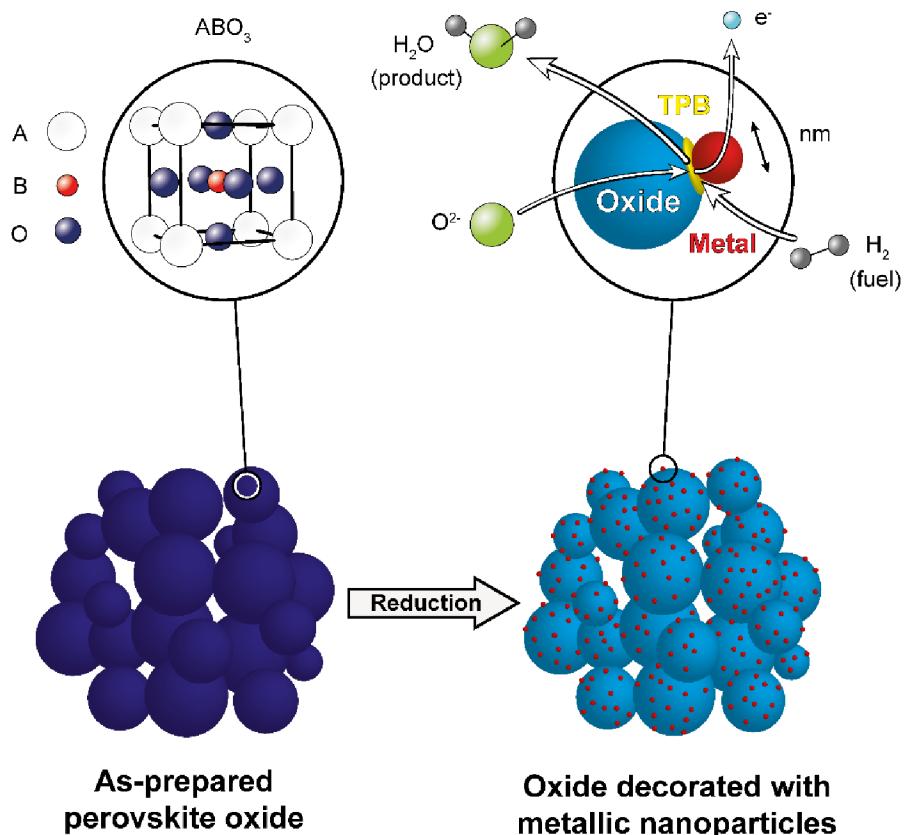
Idealized concept



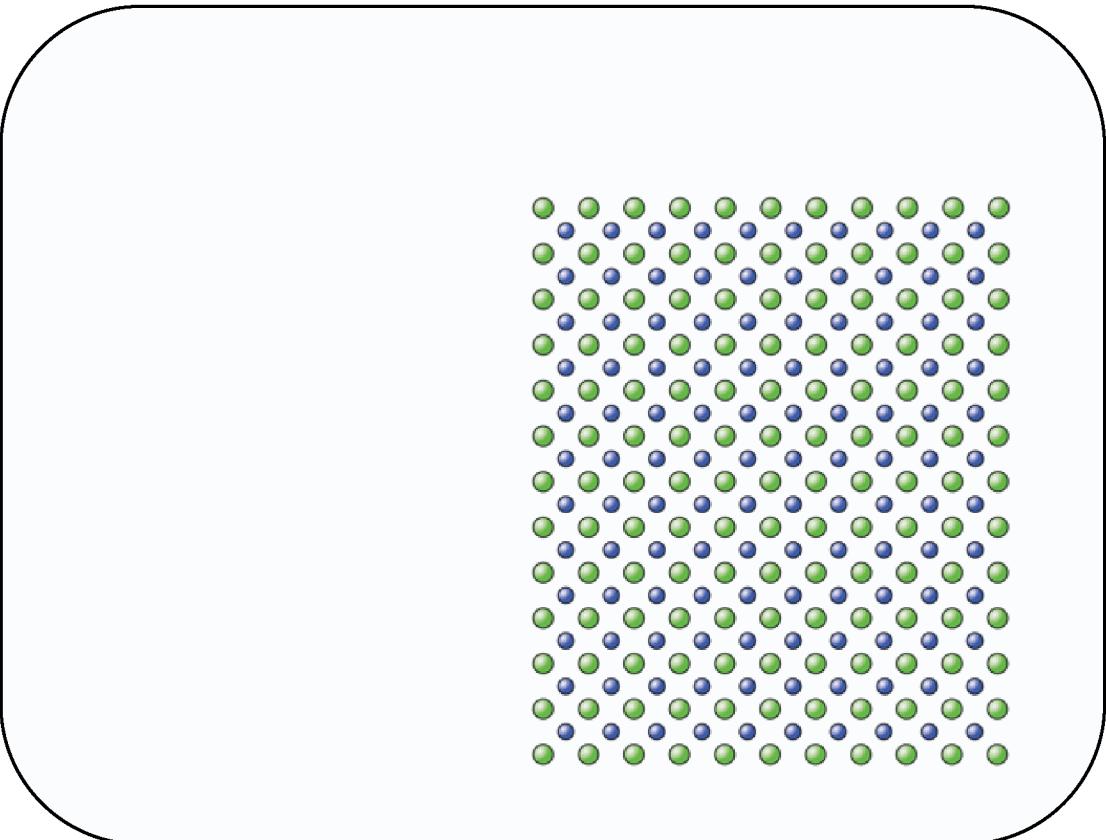
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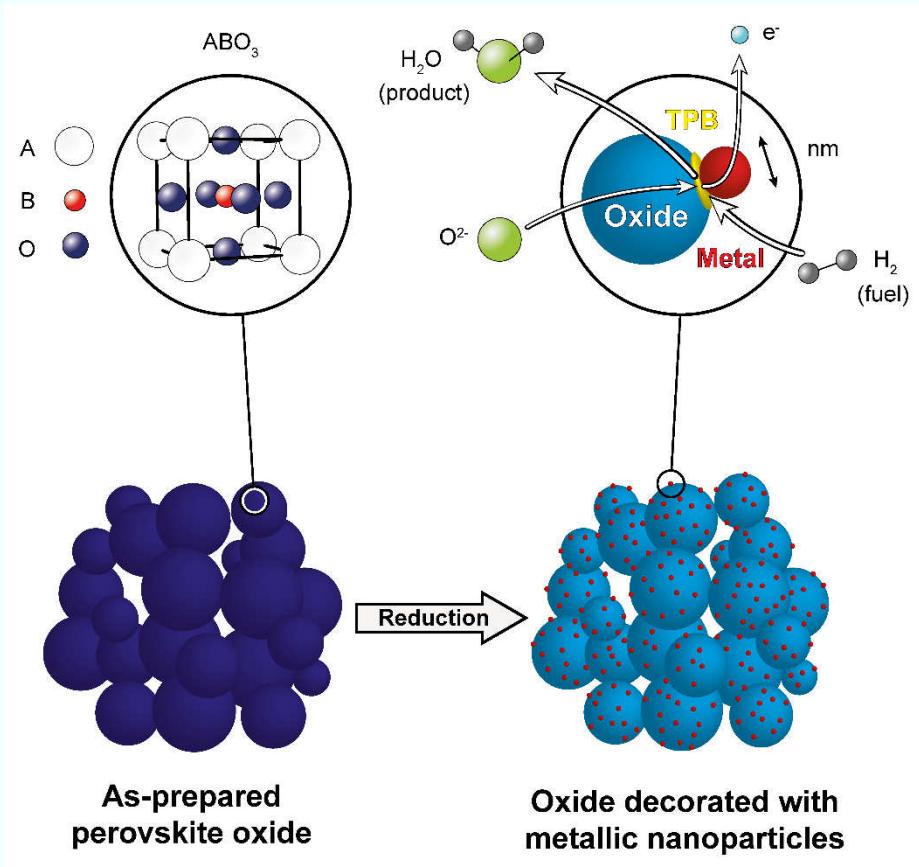
Exsolution process



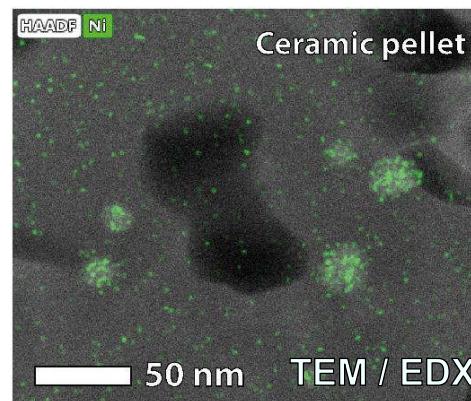
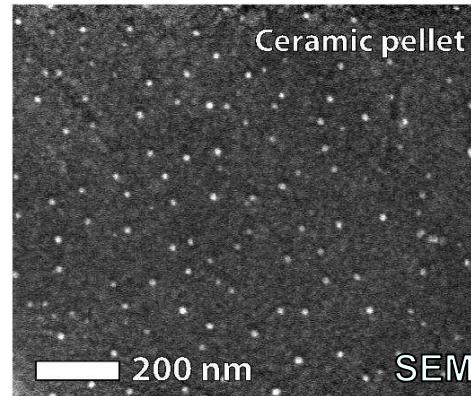
Metal exsolution

Thin film approach

Idealized concept



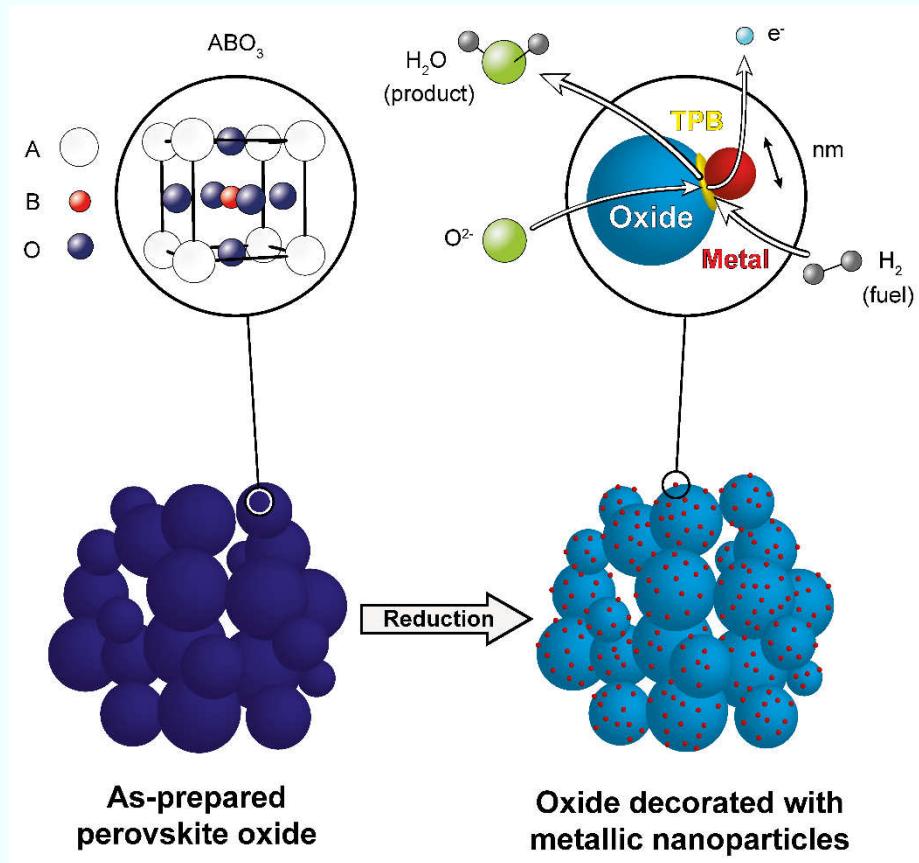
Ceramic $\text{SrTi}_{0.9}\text{Nb}_{0.05}\text{Ni}_{0.05}\text{O}_{3-6}$



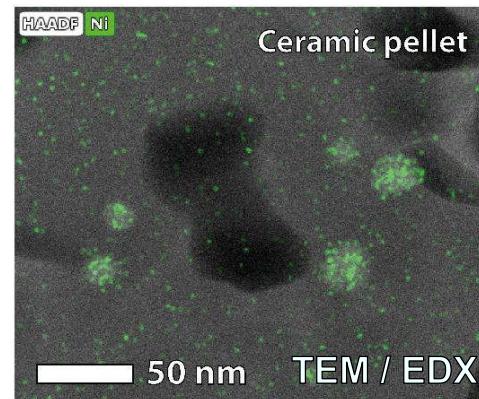
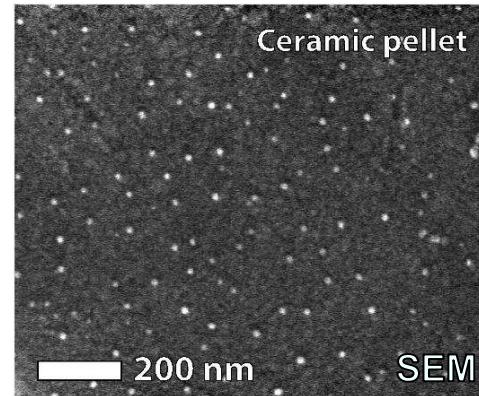
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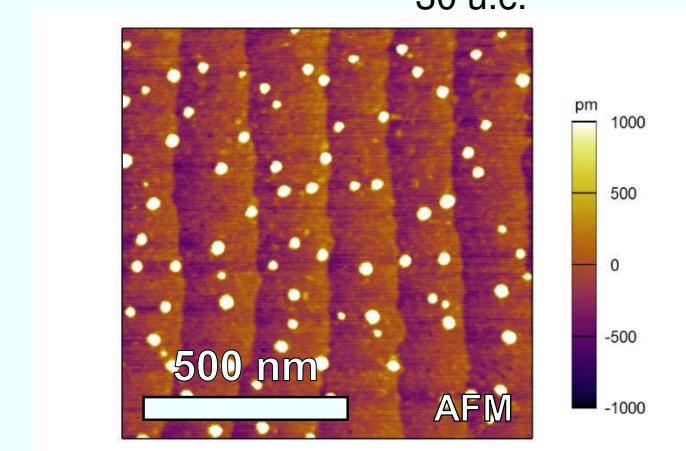
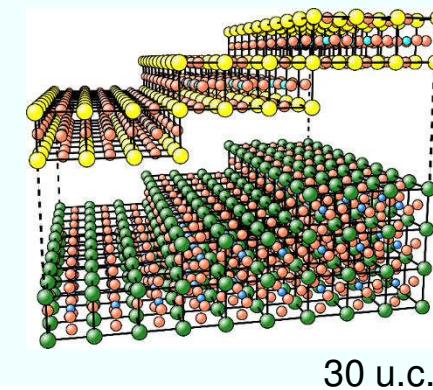
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Ceramic $\text{SrTi}_{0.9}\text{Nb}_{0.05}\text{Ni}_{0.05}\text{O}_{3-6}$

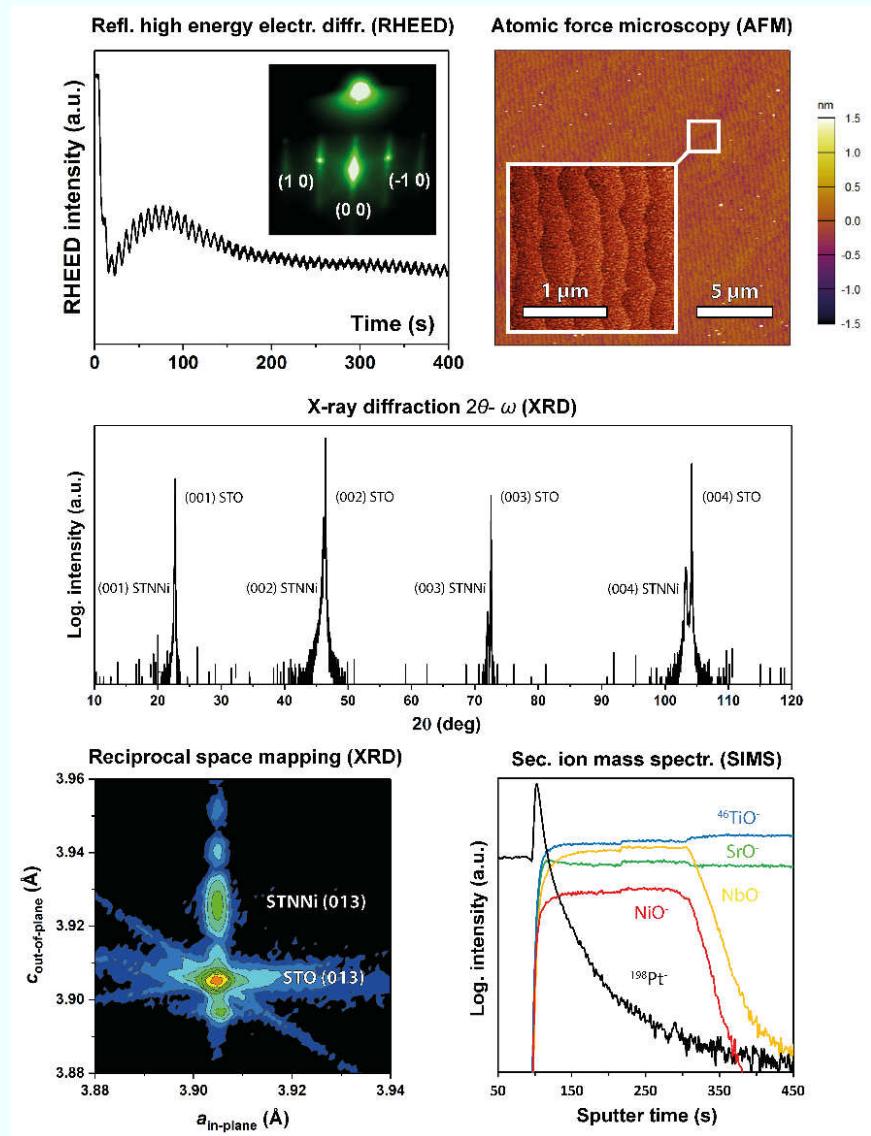


Epitaxial model systems

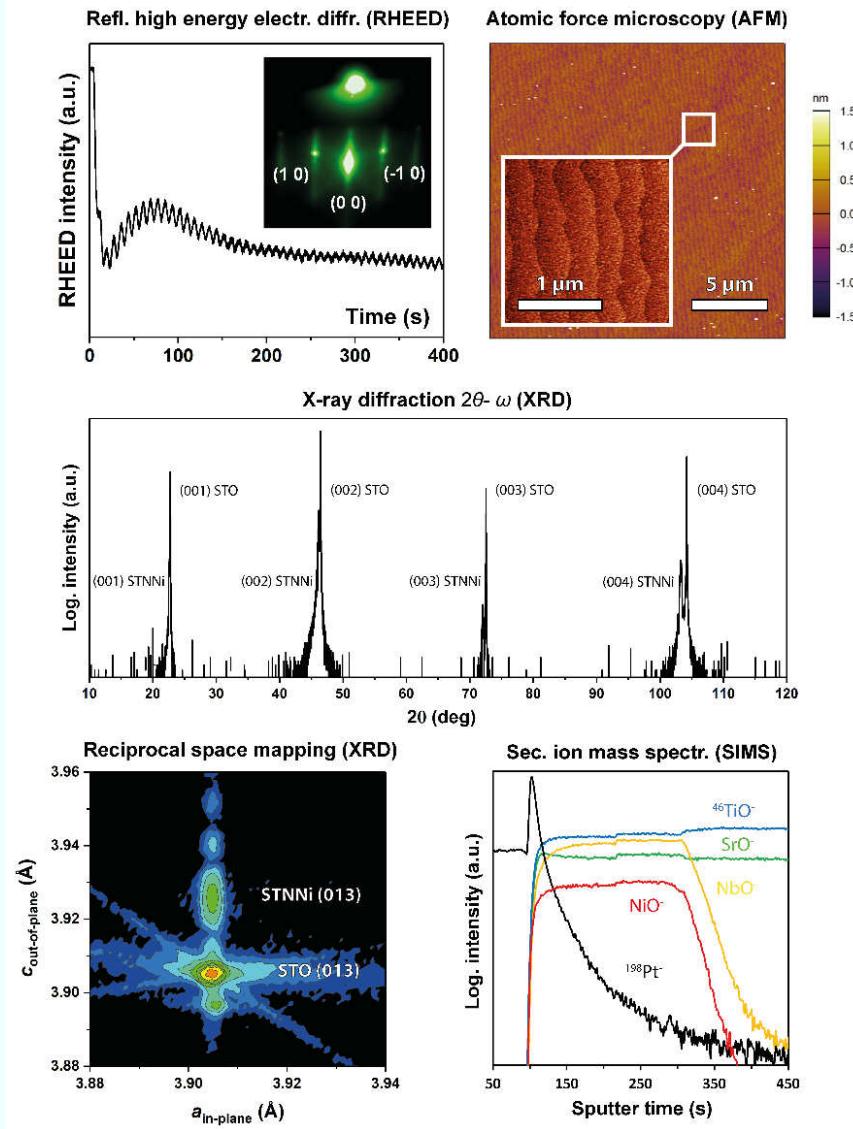


[Moritz L.
Weber and
Felix Gunkel,
*Journal of
Physics: Energy*
2019 1 (3),
2515-7655]

Metal exsolution



Metal exsolution



Reduction
(800 °C, 15h, 4% H₂ / Ar)

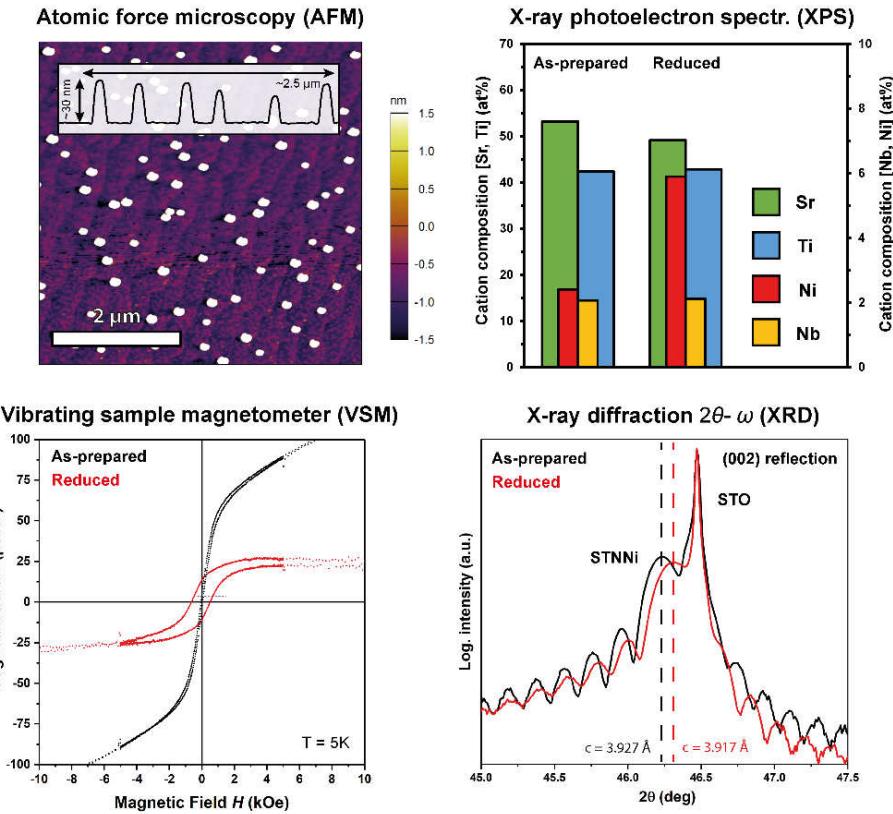
Thin film thickness 50nm

Deposition with monolayer precision

High control of material properties:

- Smooth surface
- Crystal orientation
- Strain state
- Defect structure...

Well-defined model systems for exsolution studies

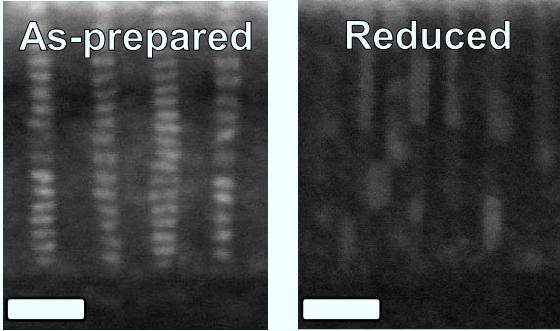


- Formation of highly dispersed nanoparticles
- Ni enrichment at the surface
- Magnetic transition to the ferromagnetic state
- Shift in the c-lattice parameter visible
- Release of Ni from the thin film lattice and the formation of metallic nanoparticles

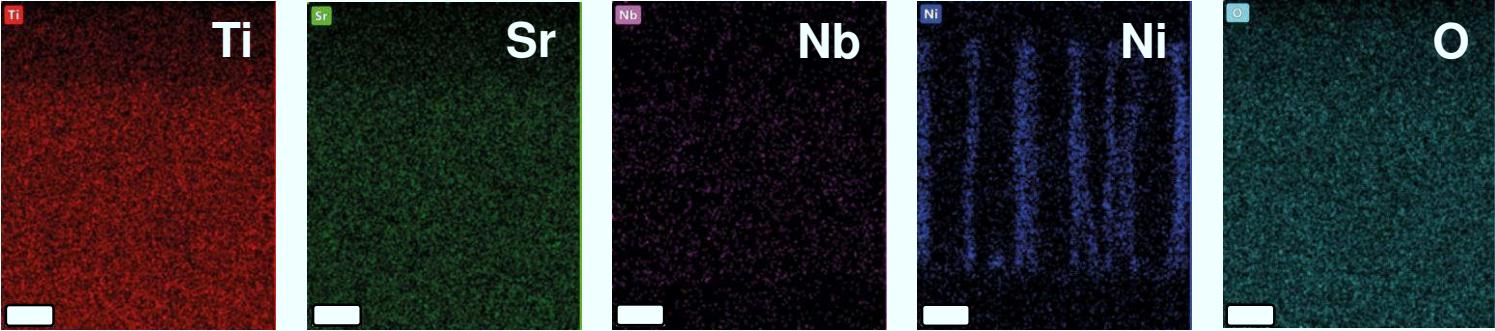
Metal exsolution

Structural properties – accomodation of Ni within the host lattice

TEM dark-field imaging



Energy dispersive X-ray spectroscopy (EDXS)

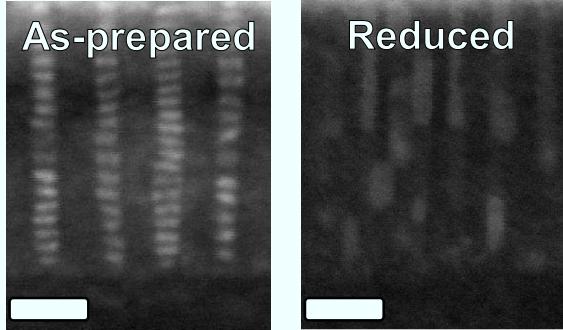


Scale bars: 20nm

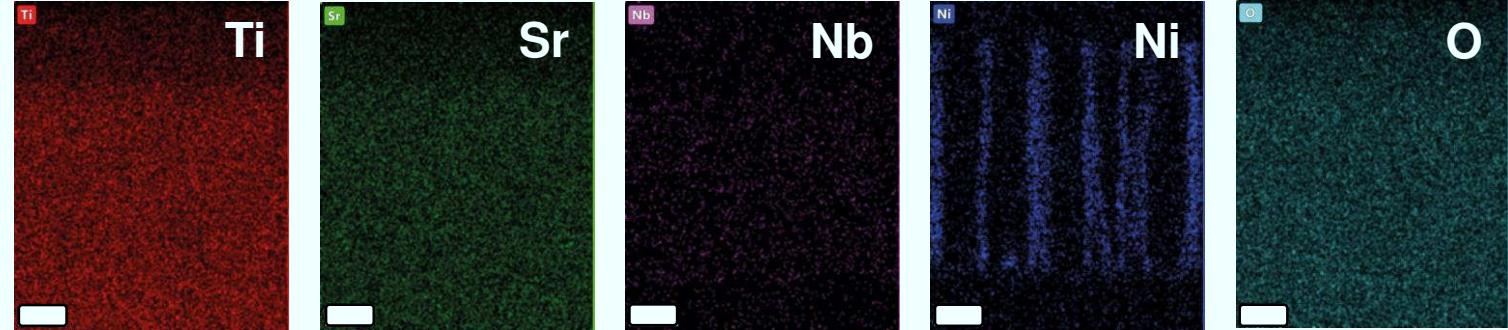
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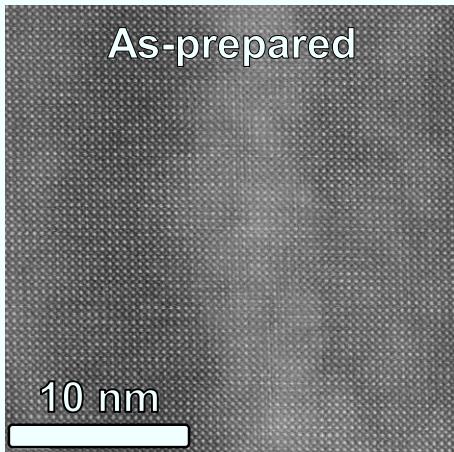
TEM dark-field imaging



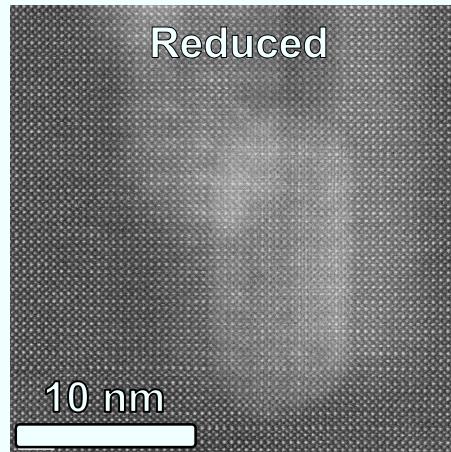
Energy dispersive X-ray spectroscopy (EDXS)



HR-STEM



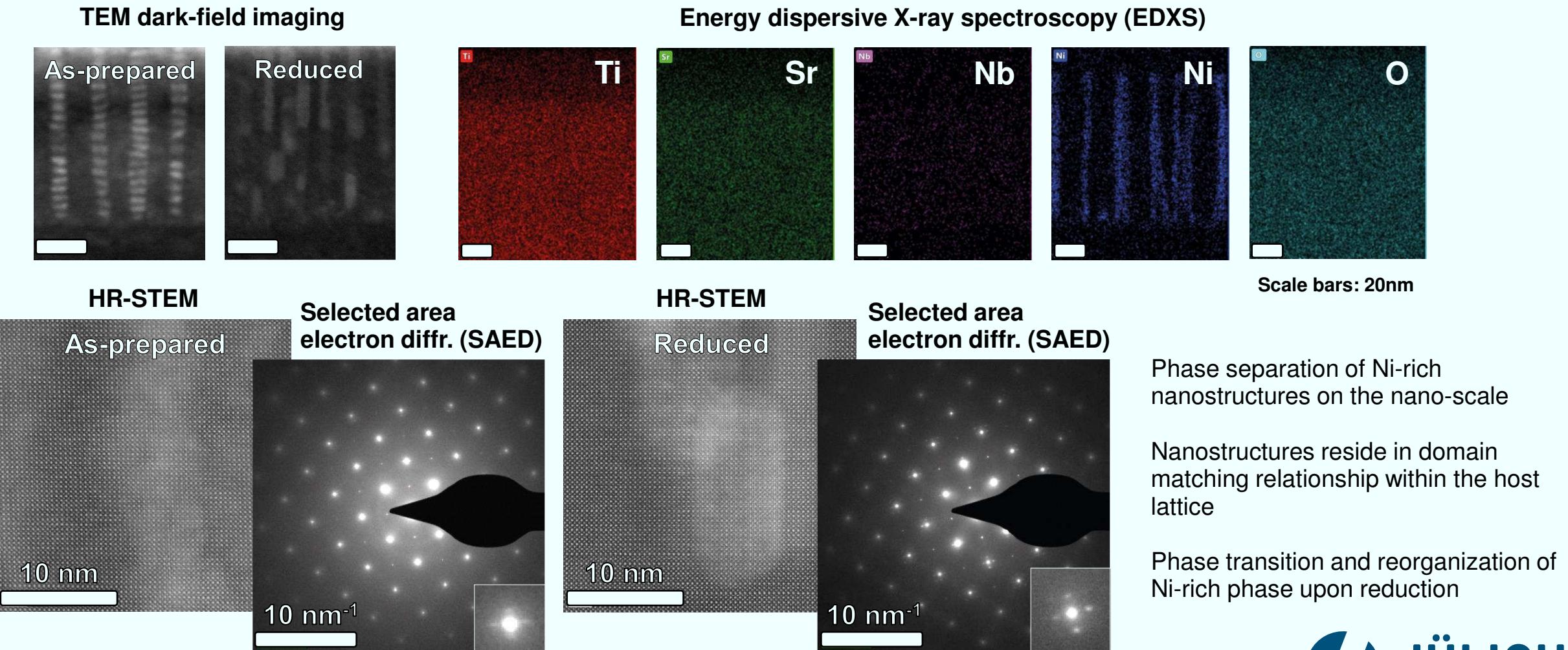
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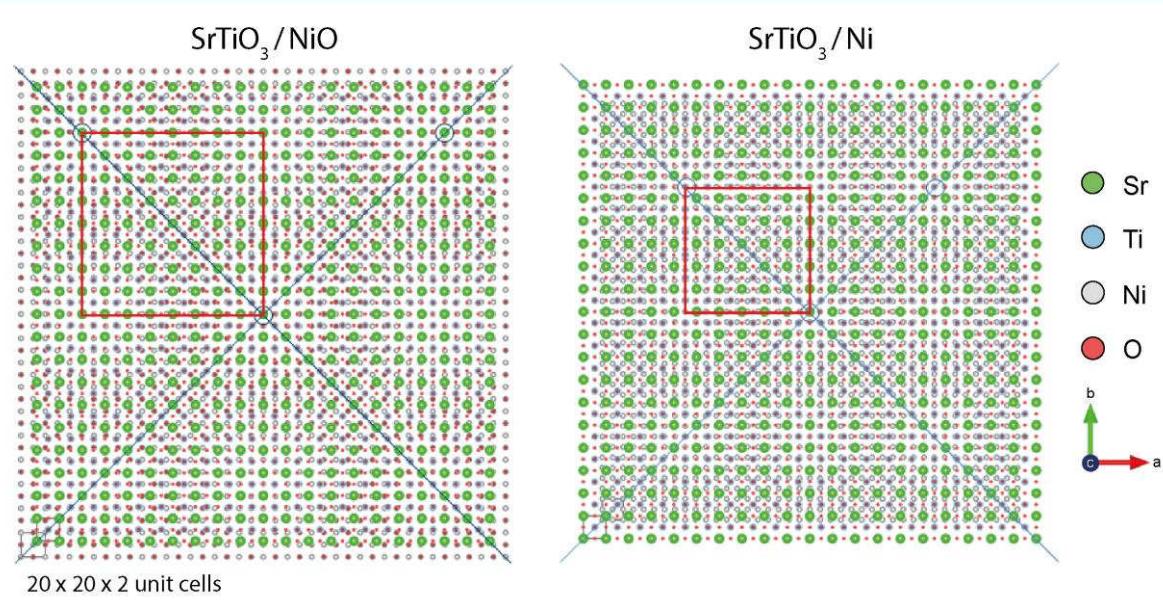
Metal exsolution

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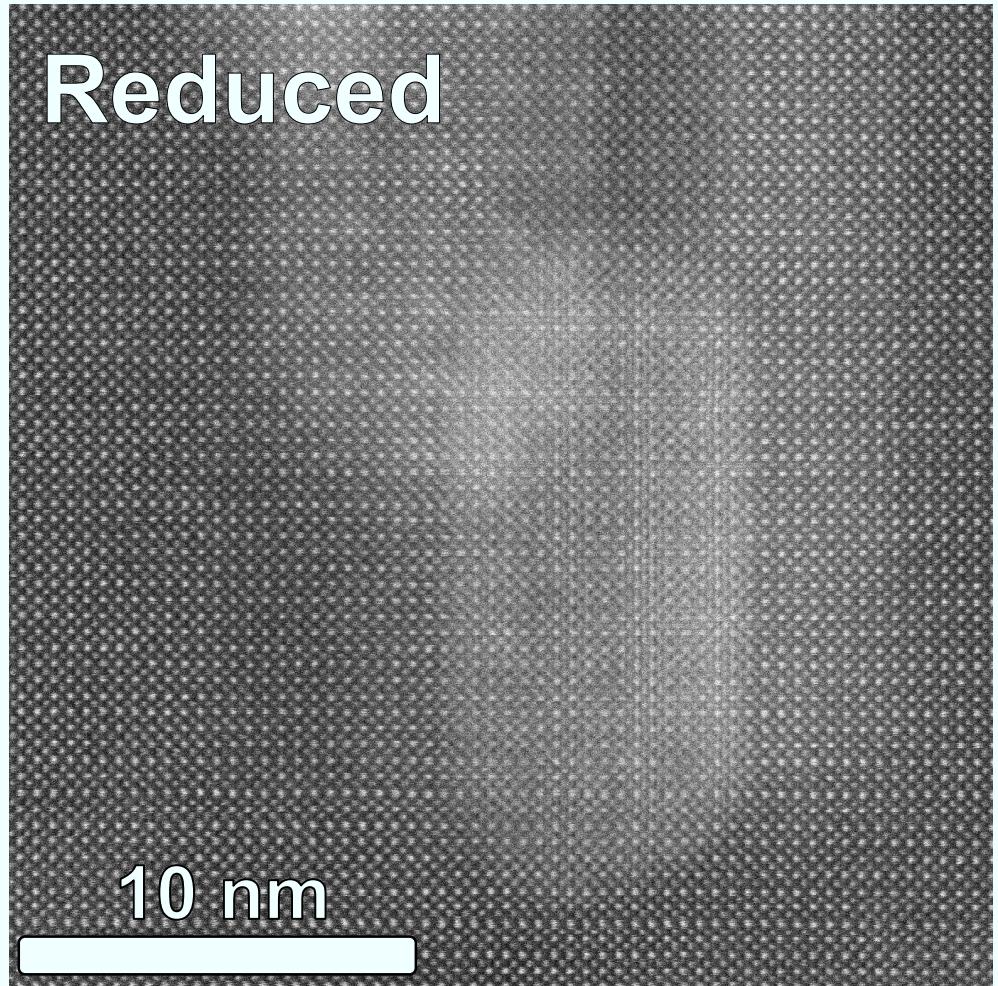
Metal exsolution

Structural properties – domain matching epitaxy



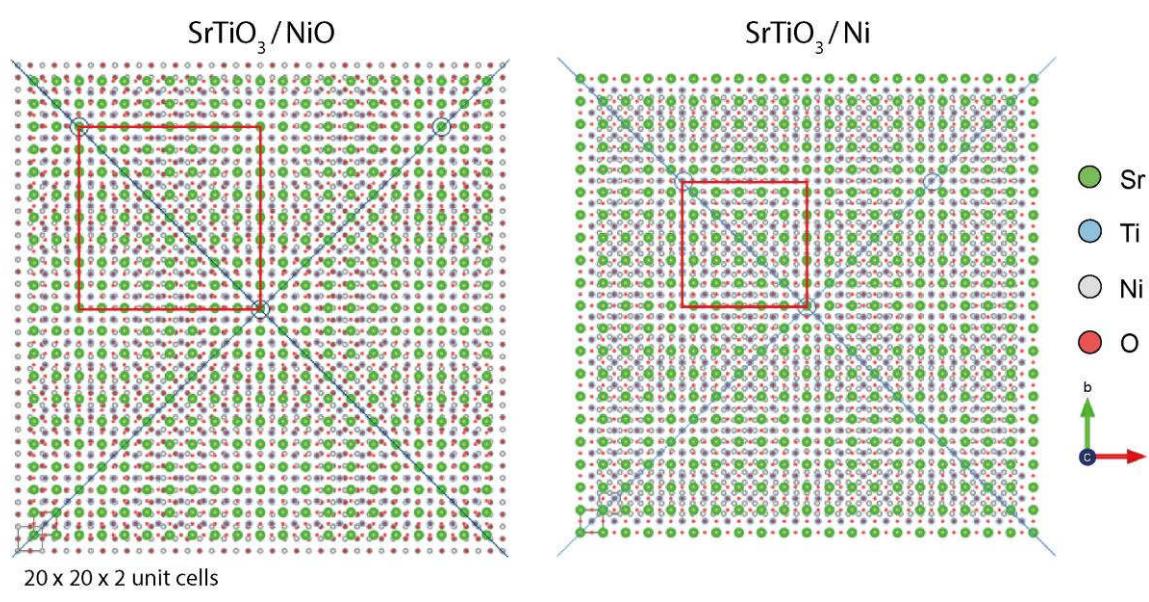
Coincidence site lattice model (CSL)

Material	Lattice parameter (Å)	Periodicity n	F (%)
STN(Ni)	3.91	~8	0.18 %
NiO	4.178	~7.5	
STN(Ni)	3.91	~5.5	-0.1 %
Ni	3.581	~6	



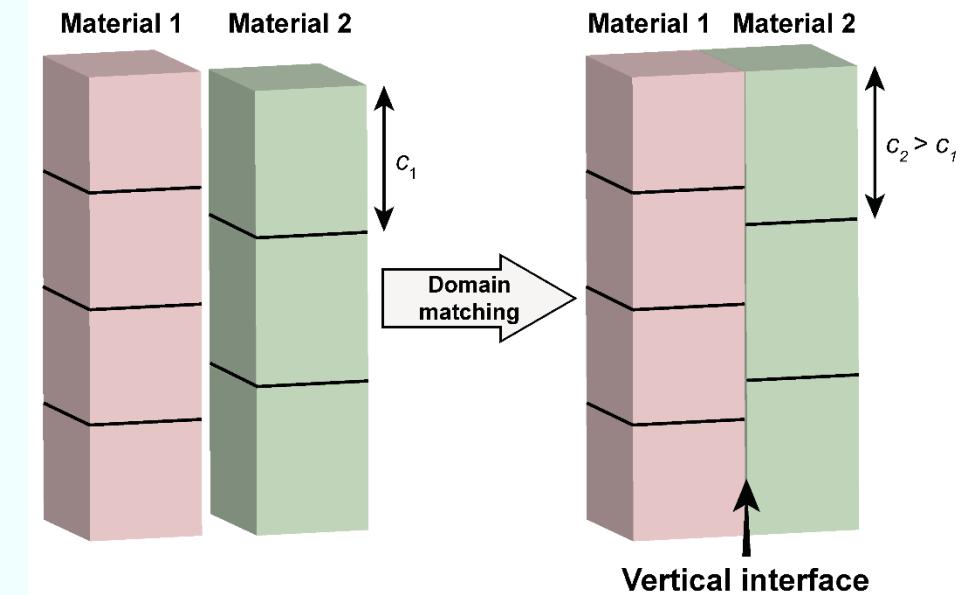
Metal exsolution

Structural properties – domain matching epitaxy



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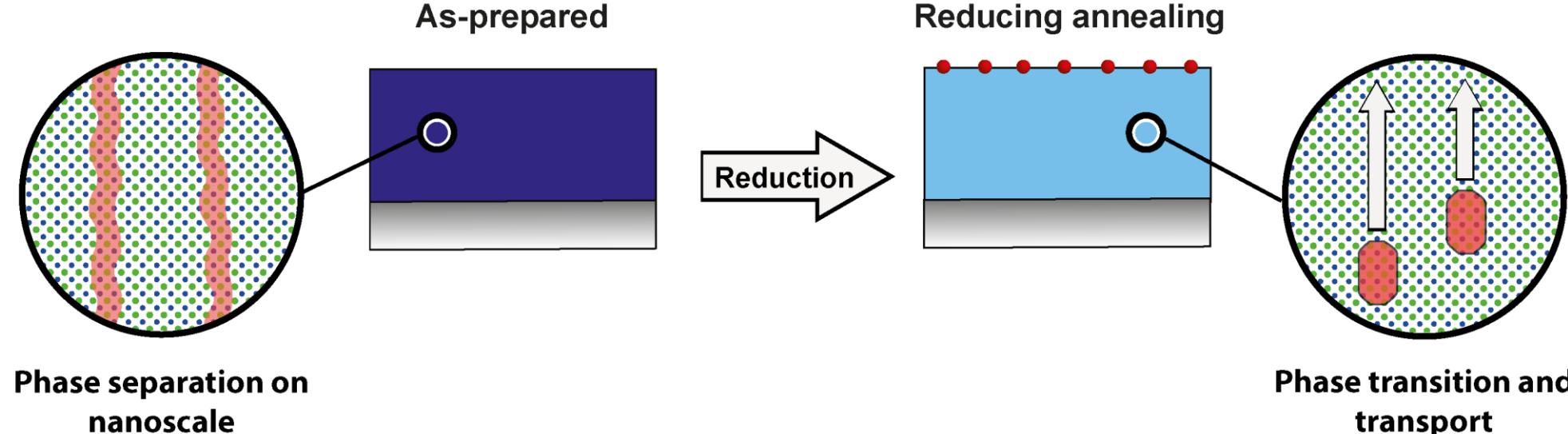
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- Structural properties determined by nature of the **semi-coherent vertical interface**
- Minimum CSL misfit, interfacial area, elastic stiffness tensors, dislocation density

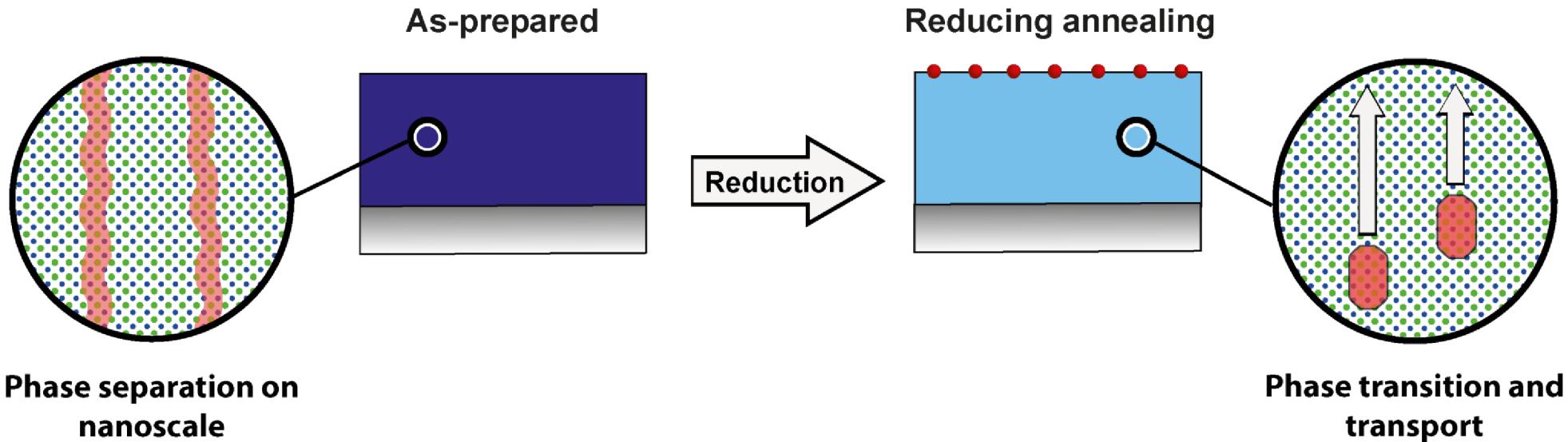
Metal exsolution

Structural properties – accomodation of Ni within the host lattice



Metal exsolution

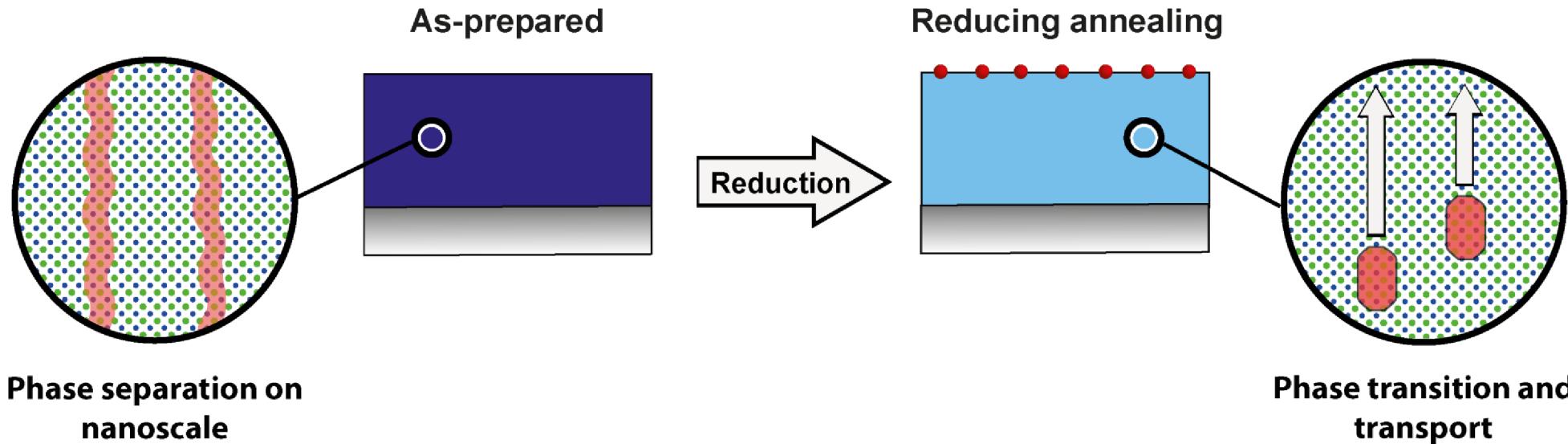
Structural properties – accomodation of Ni within the host lattice



- 1) Nanoscale phase separation
 - Exsolution of pre-formed nuclei as alternative exsolution pathway

Metal exsolution

Structural properties – accomodation of Ni within the host lattice



1) Nanoscale phase separation

→ Exsolution of pre-formed nuclei as alternative exsolution pathway

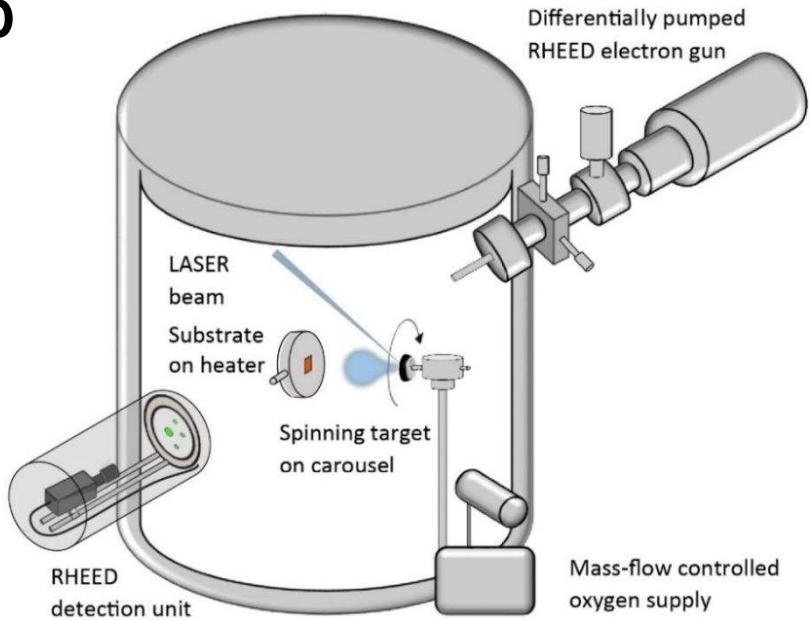
2) Decoupled nucleation and transport

→ Investigation of nanoparticle transport as isolated process

Metal exsolution

Influence of defect structure on metal exsolution

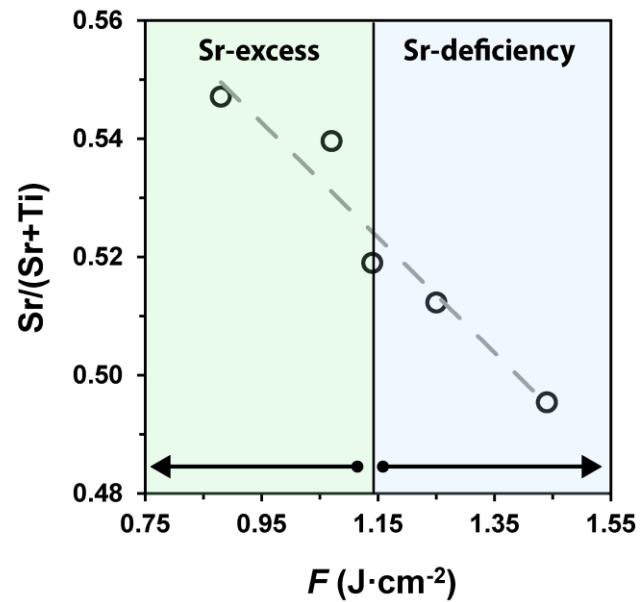
PLD



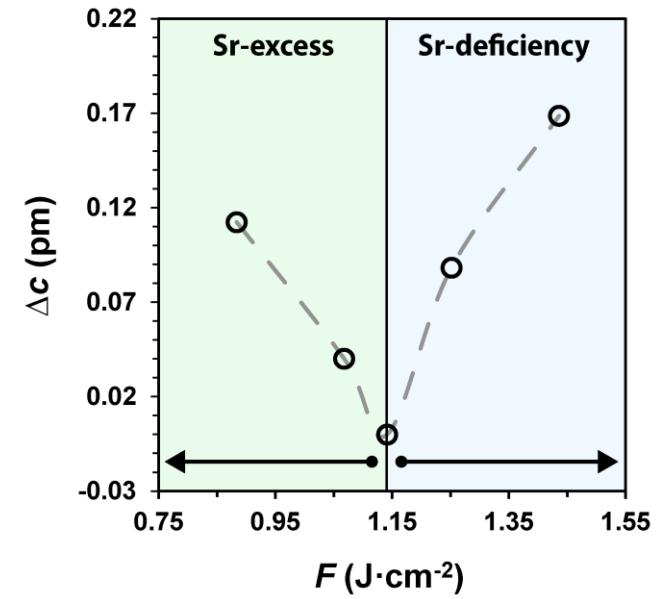
Tailoring the thin film defect structure based on the applied laser fluence F

- Amount and initial velocity of ablated species
- Plasma plume dynamics (e.g. scattering processes)

XPS



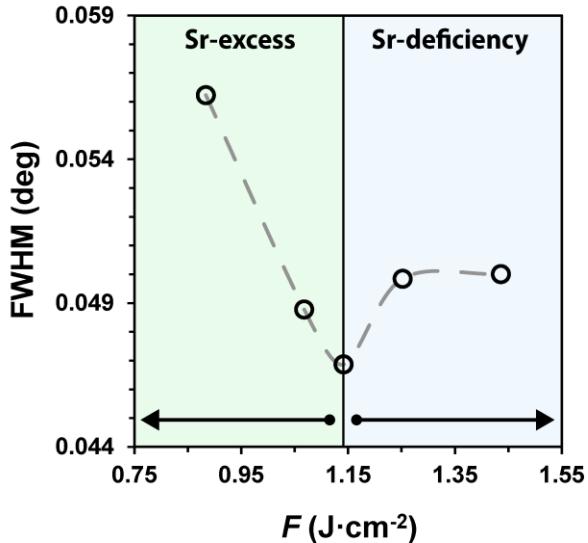
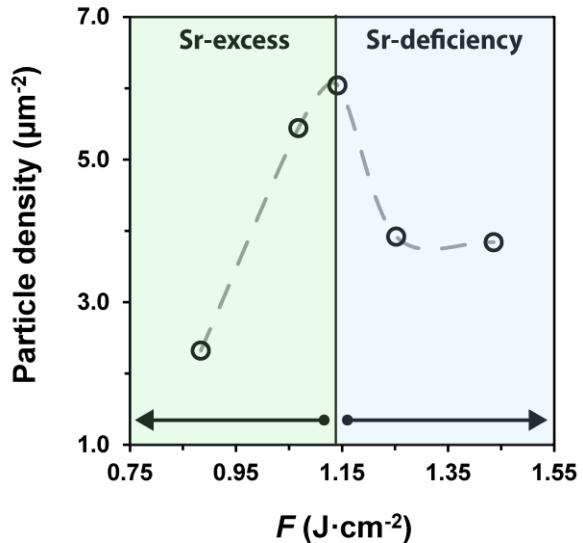
XRD



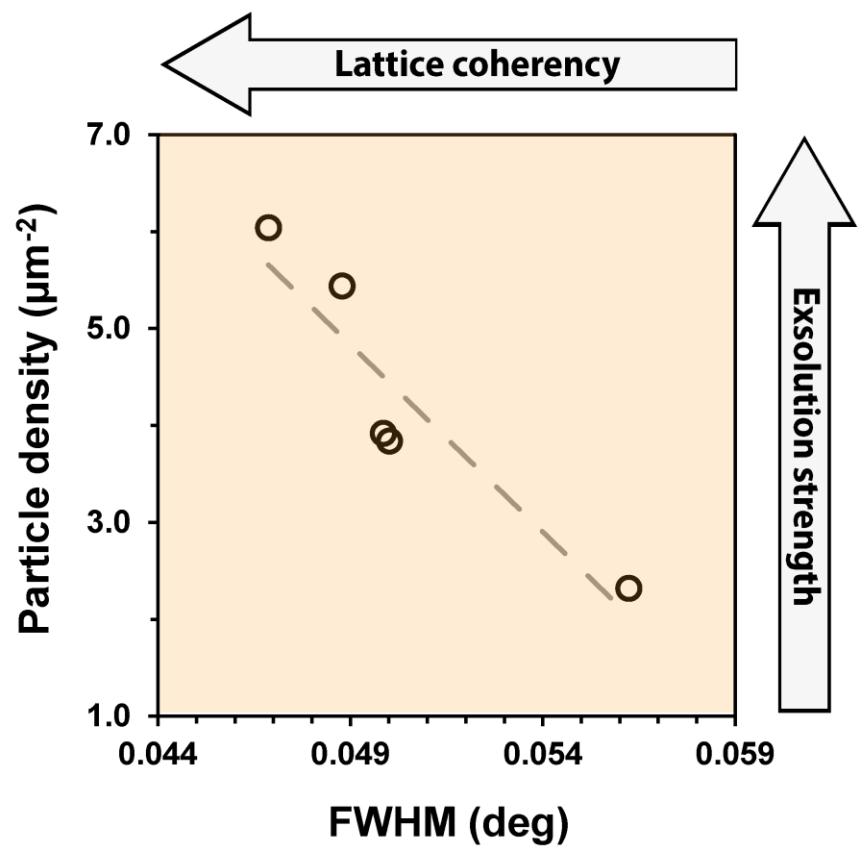
→ Incorporation of non-stoichiometry and respective defect structures resulting in systematic change in host stoichiometry and expansion of the c -lattice parameter

Metal exsolution

Influence of defect structure on metal exsolution



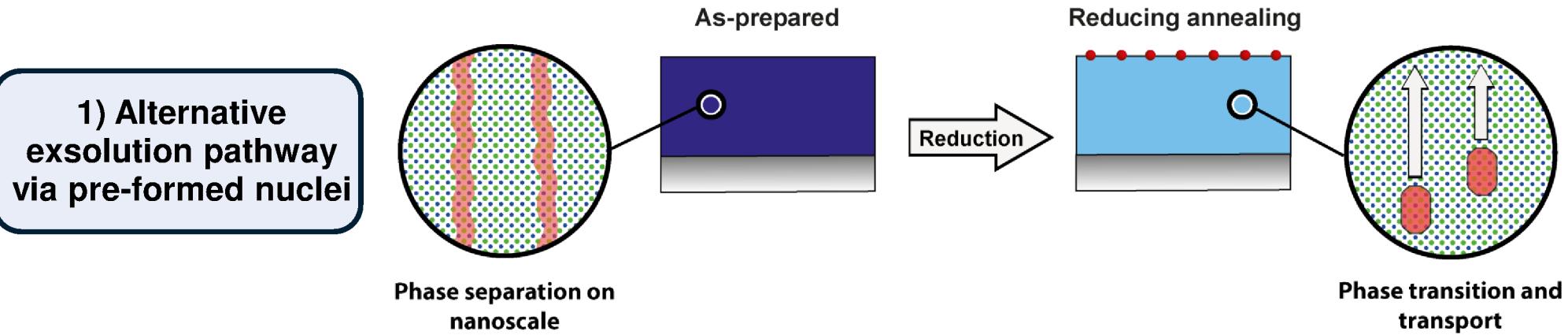
- Highest nanoparticle density for stoichiometric thin films
- Non-stoichiometry i.e. defect incorporation results in distortions of the host lattice and loss of lattice coherency



- High lattice coherency of the host lattice promotes metal exsolution to the perovskite surface

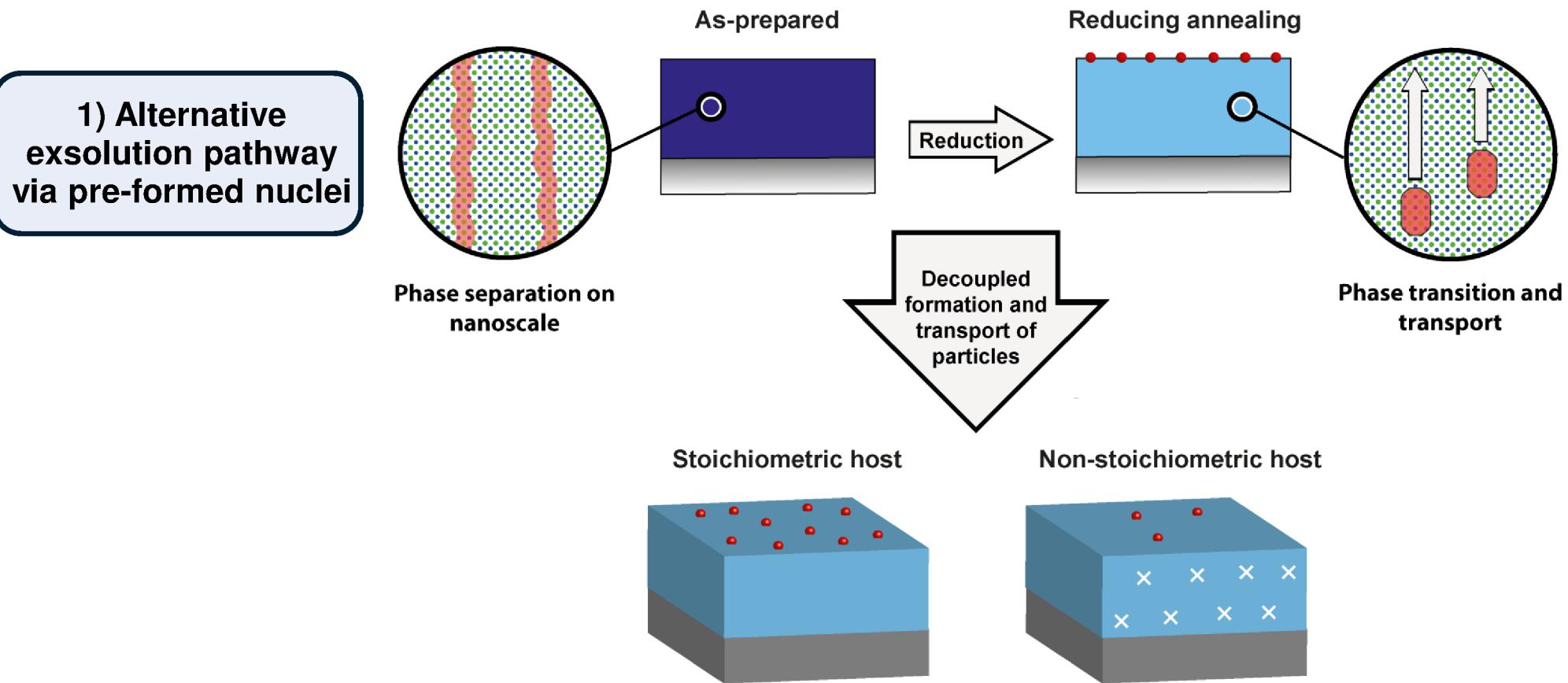
Metal exsolution

Conclusion & outlook



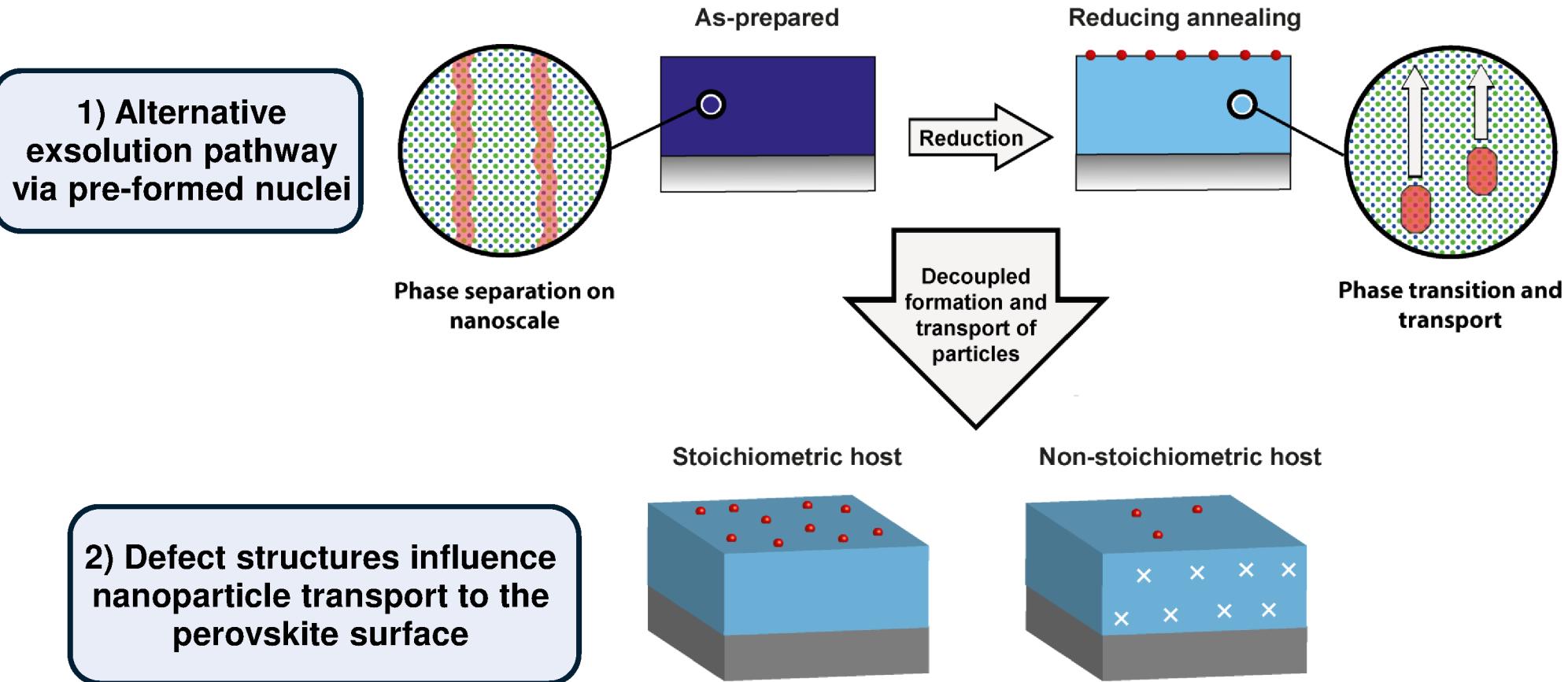
Metal exsolution

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